

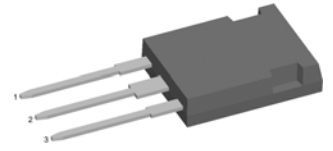
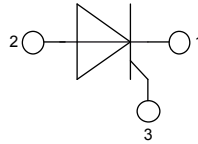
# Medium SCR

Single Thyristor

$V_{RRM} = 1200\text{ V}$   
 $I_{T(RMS)} = 126\text{ A}$   
 $I_{T(AVM)} = 80\text{ A}$

Part number

**CLA 80 E 1200 HF**



Backside: anode

**Features / Advantages:**

- Thyristor for line frequency
- Planar passivated chip
- Long-term stability of blocking currents and voltages

**Applications:**

- Motor control
- Power converter
- AC power controller
- Switch mode and resonant mode power supplies
- Light and temperature control

**Package:**

- Housing: PLUS247
- Industry standard outline
- Epoxy meets UL 94V-0
- RoHS compliant

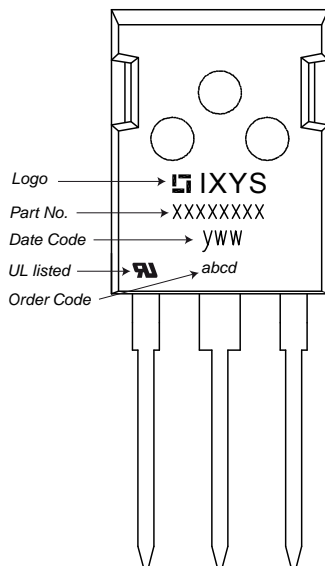
**Ratings**

Symbol	Definition	Conditions	Ratings			Unit	
			min.	typ.	max.		
$V_{RSM/DSM}$	max. non-repetitive reverse/forward blocking voltage	$T_{VJ} = 25^{\circ}\text{C}$			1300	V	
$V_{RRM/DRM}$	max. repetitive reverse/forward blocking voltage	$T_{VJ} = 25^{\circ}\text{C}$			1200	V	
$I_{RD}$	reverse current, drain current	$V_R = 1200\text{ V}$			50	$\mu\text{A}$	
		$V_R = 1200\text{ V}$	$T_{VJ} = 125^{\circ}\text{C}$		5	mA	
$V_T$	forward voltage	$I_F = 80\text{ A}$			1.40	V	
		$I_F = 160\text{ A}$			1.77	V	
		$I_F = 80\text{ A}$	$T_{VJ} = 125^{\circ}\text{C}$			1.38	V
		$I_F = 160\text{ A}$				1.67	V
$I_{T(AVM)}$	max. average forward current	$T_C = 115^{\circ}\text{C}$			80	A	
$I_{T(RMS)}$	RMS forward current	180° sine			126	A	
$V_{T0}$	threshold voltage	$T_{VJ} = 150^{\circ}\text{C}$			0.90	V	
$r_T$	slope resistance } for power loss calculation only				6	m $\Omega$	
$R_{thJC}$	thermal resistance junction to case				0.20	K/W	
$T_{VJ}$	virtual junction temperature		-40		150	$^{\circ}\text{C}$	
$P_{tot}$	total power dissipation	$T_C = 25^{\circ}\text{C}$			625	W	
$P_{GM}$	max. gate power dissipation	$t_p = 30\ \mu\text{s}$			10	W	
		$t_p = 300\ \mu\text{s}$			5	W	
$P_{GAV}$	average gate power dissipation				0.5	W	
$I_{FSM}$	max. forward surge current	$t = 10\text{ ms}; (50\text{ Hz}), \text{ sine}$	$T_{VJ} = 45^{\circ}\text{C}$		900	A	
		$t = 8,3\text{ ms}; (60\text{ Hz}), \text{ sine}$	$V_R = 0\text{ V}$		970	A	
		$t = 10\text{ ms}; (50\text{ Hz}), \text{ sine}$	$T_{VJ} = 150^{\circ}\text{C}$		765	A	
		$t = 8,3\text{ ms}; (60\text{ Hz}), \text{ sine}$	$V_R = 0\text{ V}$		825	A	
$I^2t$	value for fusing	$t = 10\text{ ms}; (50\text{ Hz}), \text{ sine}$	$T_{VJ} = 45^{\circ}\text{C}$		4.05	kA <sup>2</sup> s	
		$t = 8,3\text{ ms}; (60\text{ Hz}), \text{ sine}$	$V_R = 0\text{ V}$		3.92	kA <sup>2</sup> s	
		$t = 10\text{ ms}; (50\text{ Hz}), \text{ sine}$	$T_{VJ} = 150^{\circ}\text{C}$		2.93	kA <sup>2</sup> s	
		$t = 8,3\text{ ms}; (60\text{ Hz}), \text{ sine}$	$V_R = 0\text{ V}$		2.83	kA <sup>2</sup> s	
$C_J$	junction capacitance	$V_R = 400\text{ V}$ $f = 1\text{ MHz}$	$T_{VJ} = 25^{\circ}\text{C}$		36	pF	

Symbol	Definition	Conditions	Ratings			Unit
			min.	typ.	max.	
$(di/dt)_{cr}$	critical rate of rise of current	$T_{VJ} = 150^{\circ}\text{C}$ repetitive, $I_T = 40\text{ A}$ $f = 50\text{ Hz}$ ; $t_p = 200\ \mu\text{s}$			150	$\text{A}/\mu\text{s}$
		$I_G = 0.3\text{ A}$ ; $di_G/dt = 0.3\text{ A}/\mu\text{s}$ $V_D = \frac{2}{3} V_{DRM}$ non-repetitive, $I_T = 50\text{ A}$			500	$\text{A}/\mu\text{s}$
$(dv/dt)_{cr}$	critical rate of rise of voltage	$V_D = \frac{2}{3} V_{DRM}$ $T_{VJ} = 150^{\circ}\text{C}$ $R_{GK} = \infty$ ; method 1 (linear voltage rise)			1000	$\text{V}/\mu\text{s}$
$V_{GT}$	gate trigger voltage	$V_D = 6\text{ V}$ $T_{VJ} = 25^{\circ}\text{C}$ $T_{VJ} = -40^{\circ}\text{C}$			1.5	V
$I_{GT}$	gate trigger current	$V_D = 6\text{ V}$ $T_{VJ} = 25^{\circ}\text{C}$ $T_{VJ} = -40^{\circ}\text{C}$			1.6	V
					38	mA
$V_{GD}$	gate non-trigger voltage	$V_D = \frac{2}{3} V_{DRM}$ $T_{VJ} = 150^{\circ}\text{C}$			0.2	V
$I_{GD}$	gate non-trigger current				5	mA
$I_L$	latching current	$t_p = 10\ \mu\text{s}$ $T_{VJ} = 25^{\circ}\text{C}$ $I_G = 0.3\text{ A}$ ; $di_G/dt = 0.3\text{ A}/\mu\text{s}$			150	mA
$I_H$	holding current	$V_D = 6\text{ V}$ $R_{GK} = \infty$ $T_{VJ} = 25^{\circ}\text{C}$			100	mA
$t_{gd}$	gate controlled delay time	$V_R = \frac{1}{2} V_{DRM}$ $T_{VJ} = 25^{\circ}\text{C}$ $I_G = 0.3\text{ A}$ ; $di_G/dt = 0.3\text{ A}/\mu\text{s}$			2	$\mu\text{s}$
$t_q$	turn-off time	$V_R = 100\text{ V}$ ; $I_T = 48\text{ A}$ $T_{VJ} = 25^{\circ}\text{C}$ $V_D = \frac{2}{3} V_{DRM}$ ; $t_p = 200\ \mu\text{s}$ $di/dt = 20\text{ A}/\mu\text{s}$ ; $dv/dt = 20\text{ V}/\mu\text{s}$		150		$\mu\text{s}$

Symbol	Definition	Conditions	Ratings			Unit
			min.	typ.	max.	
$I_{RMS}$	RMS current	per pin <sup>1)</sup>			70	A
$R_{thCH}$	thermal resistance case to heatsink			0.25		K/W
$T_{stg}$	storage temperature		-55		150	°C
<b>Weight</b>				6		g
$F_C$	mounting force with clip		20		120	N

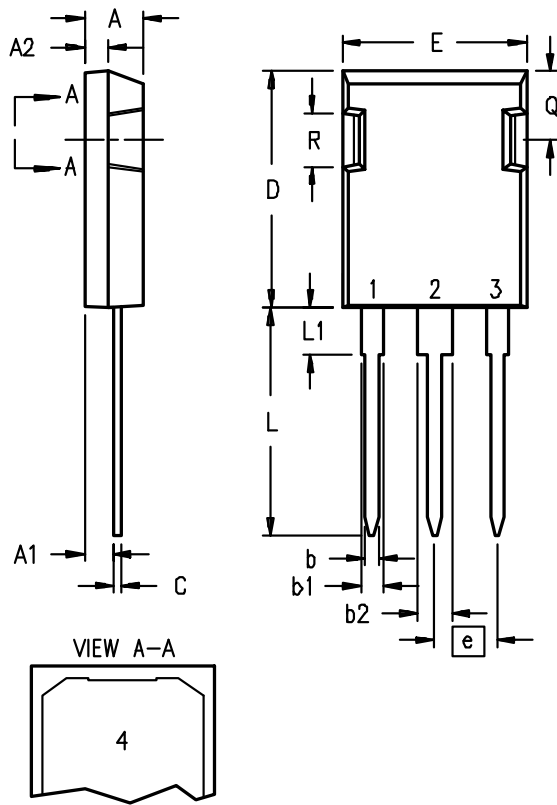
<sup>1)</sup>  $I_{RMS}$  is typically limited by: 1. pin-to-chip resistance; or by 2. current capability of the chip.  
 In case of 1, a common cathode/anode configuration and a non-isolated backside, the whole current capability can be used by connecting the backside.

**Product Marking**

**Part number**

C = Thyristor (SCR)  
 L = Medium SCR  
 A = (up to 1200V)  
 80 = Current Rating [A]  
 E = Single Thyristor  
 1200 = Reverse Voltage [V]  
 HF = PLUS247 (3)

Ordering	Part Name	Marking on Product	Delivering Mode	Base Qty	Code Key
Standard	CLA 80 E 1200 HF	CLA80E1200HF	Tube	30	508680

Outlines PLUS247



Dim.	Millimeter		Inches	
	Min.	Max.	Min.	Max.
A	4.83	5.21	0.19	0.205
A1	2.29	2.54	0.09	0.1
A2	1.91	2.16	0.075	0.085
b	1.14	1.4	0.045	0.055
b1	1.91	2.13	0.075	0.084
b2	2.92	3.12	0.115	0.123
C	0.61	0.8	0.024	0.031
D	20.8	21.34	0.819	0.84
E	15.75	16.13	0.62	0.635
e	5.45 BSC		.215 BSC	
L	19.81	20.32	0.78	0.8
L1	3.81	4.32	0.15	0.17
Q	5.59	6.2	0.22	0.244
R	4.32	4.83	0.17	0.19